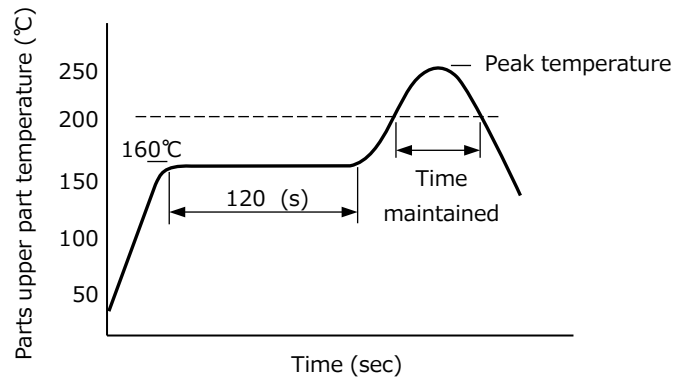


## Recommendable reflow solde

- RoHS compliant



## Lead-Free reflow

Reflow No.	(1)	(2)	(3)	(4)
Category	φ4 to φ6.3	φ8 to φ10	φ12.5 to φ18	EB series (φ10 to φ18)
Peak temperature	250 °C	235 °C	230 °C (220 °C)	230 °C
Time in peak temperature	5 s	5 s	5 s (5 s )	5 s
Time maintained	≥200 °C 60 s	≥200 °C 60 s	≥200 °C 20 s (30 s)	≥200 °C 20 s
Time of reflow	1 time	1 time	1 time	1 time

## High temperature Lead-Free reflow

Reflow No.	(5)	(6)		(7)		(8)	
Category	φ4 to φ6.3	φ8 to φ10		φ8 to φ10		φ6.3 to φ10 (TK·TP series )	
Peak temperature	260 °C (255 °C)	245 °C	260 °C	250 °C	260 °C	255 °C	260 °C
Time in peak temperature	≥250 °C 5 s (10 s)	≥240 °C 10 s	≥250 °C 5 s	≥240 °C 10 s	≥250 °C 5 s	≥250 °C 30 s	≥250 °C 20 s
Time maintained	≥230 °C 30 s	≥230 °C 30 s	≥230 °C 30 s	≥230 °C 30 s	≥230 °C 30 s	≥230 °C 40 s	≥230 °C 30 s
	≥217 °C 40 s	≥217 °C 40 s	≥217 °C 40 s	≥217 °C 40 s	≥217 °C 40 s	≥217 °C 65 s	≥217 °C 65 s
	≥200 °C 70 s	≥200 °C 70 s	≥200 °C 70 s	≥200 °C 70 s	≥200 °C 70 s	≥200 °C 90 s	≥200 °C 70 s
Time of reflow	2 times	2 times	1 time	2 times	1 time	2 times	2 times

Reflow No.	(9)	(10)	(11)
Category	φ12.5 to φ18 (FK, TK, HD) 6.3 V to 35 V	φ12.5 to φ18 (FK) 50 V to 63 V (TK) 50 V	φ12.5 to φ18 (FK) 80 V to 100 V (TK) 63 V to 100 V
Peak temperature	245 °C	245 °C	245 °C
Time in peak temperature	≥240 °C 30 s	≥240 °C 5 s	≥240 °C 5 s
Time maintained	≥217 °C 90 s	≥217 °C 30 s	≥217 °C 30 s
Time of reflow	2 times	2 times	1 time

\* For reflow, use a thermal condition system such as infrared radiation (IR) or hot blast.

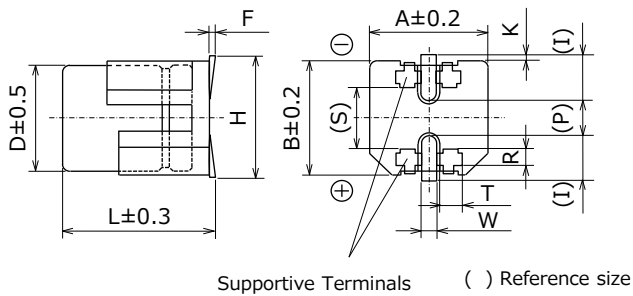
\* Panasonic have several series available for pure Tin terminal and ZVEI reflow based on J-STD-020D (JEDEC).

(Please contact sales for details.)

## Dimensions (Vibration-proof products)

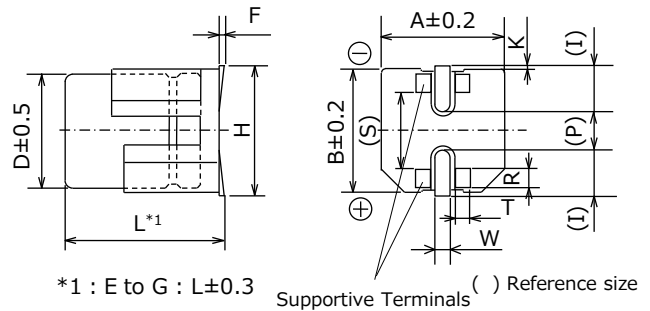
\* The size and shape are different from standard products. Please inquire details of our company.

< Size code : D, D8 >



Supportive Terminals ( ) Reference size

< Size code : E, F, G, H13, J16, K16, K21 >



\*1 : E to G : L±0.3  
H13 to K21 : L±0.5

Supportive Terminals ( ) Reference size

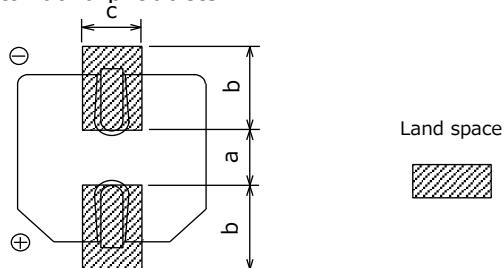
Unit : mm

Size code	φD	L	A, B	H max.	F	I	W	P	K	R	S	T
D	6.3	6.1	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 <sup>+0.15/-0.20</sup>	1.1±0.2	3.3	1.05±0.2
D8	6.3	8.0	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 <sup>+0.15/-0.20</sup>	1.1±0.2	3.3	1.05±0.2
E	8.0	6.5	8.3	9.5	0 to +0.15	3.4	0.7±0.1	2.2	0.35 <sup>+0.15/-0.20</sup>	0.70±0.2	5.3	1.7±0.2
F	8.0	10.5	8.3	10.0	0 to +0.15	3.4	1.2±0.2	3.1	0.70±0.2	0.70±0.2	5.3	1.3±0.2
G	10.0	10.5	10.3	12.0	0 to +0.15	3.5	1.2±0.2	4.6	0.70±0.2	0.70±0.2	6.9	1.3±0.2
H13	12.5	13.8	13.5	15.0	-0.1 to +0.15	4.7	1.2±0.2	4.4	0.70±0.3	2.2±0.2	7.1	2.4±0.2
J16	16.0	16.8	17.0	19.0	-0.1 to +0.15	5.5	1.4±0.2	6.7	0.70±0.3	3.0±0.2	9.0	1.9±0.2
K16	18.0	16.8	19.0	21.0	-0.1 to +0.15	6.7	1.4±0.2	6.7	0.70±0.3	3.0±0.2	11.0	1.9±0.2
K21	18.0	21.8	19.0	21.0	-0.1 to +0.15	6.7	1.4±0.2	6.7	0.70±0.3	3.0±0.2	11.0	1.9±0.2

## Land / Pad pattern

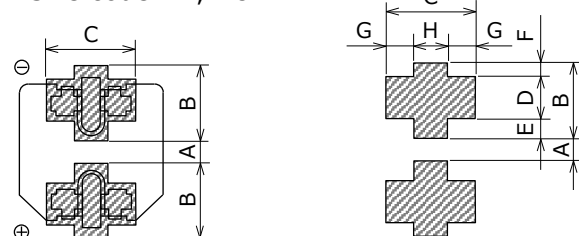
The circuit board land/pad pattern size for chip capacitors is specified in the following table.  
The land pitch influences installation strength and consider it.

● Standard products

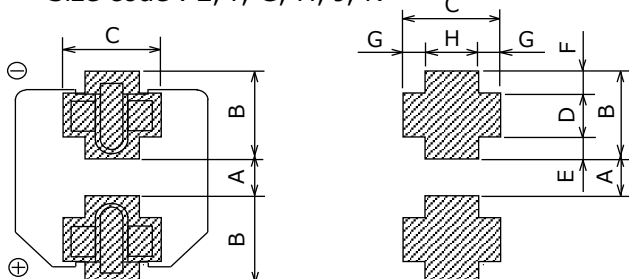


● Vibration-proof products

< Size code : D, D8 >



< Size code : E, F, G, H, J, K >



(Table of board land size vs. capacitor size)

Unit : mm

Size code	a	b	c
B (φ4)	1.0	2.5	1.6
C (φ5)	1.5	2.8	1.6
D (φ6.3)	1.8	3.2	1.6
D8 (φ6.3x7.7L)	1.8	3.2	1.6
E (φ8x6.2L)	2.2	4.0	1.6
F (φ8x10.2L)	3.1	4.0	2.0
G (φ10x10.2L)	4.6	4.1	2.0
H (φ12.5)	4.0	5.7	2.0
J (φ16)	6.0	6.5	2.5
K (φ18)	6.0	7.5	2.5

When size "a" is wide, back fillet can be made, decreasing fitting strength.

(Table of board land size vs. capacitor size)

Unit : mm

Size code	A	B	C	D	E	F	G	H
D (φ6.3xL6.1)	1.2	3.6	3.2	2.0	0.95	0.65	1.0	1.2
D8 (φ6.3xL8.0)	1.2	3.6	3.2	2.0	0.95	0.65	1.0	1.2
E (φ8x6.5L)	1.8	4.2	5.0	1.3	1.5	1.4	1.5	2.0
F (φ8x10.5L)	2.7	4.0	4.7	1.3	1.0	1.7	1.1	2.5
G (φ10)	3.9	4.4	4.7	1.3	1.2	1.9	1.1	2.5
H (φ12.5)	3.9	6.0	6.9	2.8	1.3	1.9	2.2	2.5
J (φ16)	5.8	6.8	6.2	3.6	1.3	1.9	1.7	2.8
K (φ18)	5.8	7.3	6.2	3.6	1.8	1.9	1.7	2.8

When size "A" is wide, back fillet can be made, decreasing fitting strength.

\* Take mounting conditions, solderability and fitting strength into consideration when selecting parts for your company's design.

\* The vibration-proof capacitors of size φ6.3 has support terminals extending from the bottom side to the lead edge. Then, make sure to find appropriate soldering conditions to form fillet on the support terminals if required for appearance inspection.